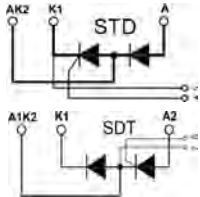


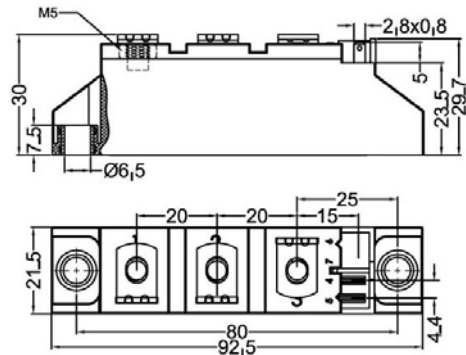
STD70GKXX

Thyristor-Diode Modules



Type	V_{RSM} V_{DSM} V	V_{RRM} V_{DRM} V
STD70GK08	900	800
STD70GK12	1300	1200
STD70GK14	1500	1400
STD70GK16	1700	1600
STD70GK18	1900	1800
STD70GK20	2100	2000
STD70GK22	2300	2200
STD70GK24	2500	2400

Dimensions in mm (1mm=0.0394")



Symbol	Test Conditions	Maximum Ratings	Unit
I_{TRMS}, I_{FRMS} I_{TAVM}, I_{FAVM}	$T_V = T_{VJM}$ $T_C = 85^\circ C; 180^\circ$ sine	180 70	A
I_{TSM}, I_{FSM}	$T_V = 45^\circ C$ $V_R = 0$ $t = 10ms$ (50Hz), sine $t = 8.3ms$ (60Hz), sine	1600 1700	A
	$T_V = T_{VJM}$ $V_R = 0$ $t = 10ms$ (50Hz), sine $t = 8.3ms$ (60Hz), sine	1450 1550	
$\int i^2 dt$	$T_V = 45^\circ C$ $V_R = 0$ $t = 10ms$ (50Hz), sine $t = 8.3ms$ (60Hz), sine	13500 12600	A ² s
	$T_V = T_{VJM}$ $V_R = 0$ $t = 10ms$ (50Hz), sine $t = 8.3ms$ (60Hz), sine	10600 10250	
$(di/dt)_{cr}$	$T_V = T_{VJM}$ $f = 50Hz, t_p = 200\mu s$ $V_D = 2/3 V_{DRM}$ $I_G = 0.45A$ $di_G/dt = 0.45A/\mu s$	repetitive, $I_T = 250A$ 150	A/ μs
		non repetitive, $I_T = I_{TAVM}$ 500	
$(dv/dt)_{cr}$	$T_V = T_{VJM};$ $R_{GK} = \infty;$ method 1 (linear voltage rise)	$V_{DR} = 2/3 V_{DRM}$ 1000	V/ μs
P_{GM}	$T_V = T_{VJM}$ $I_T = I_{TAVM}$	$t_p = 30\mu s$ 10	W
		$t_p = 300\mu s$ 5	
P_{GAV}		0.5	W
V_{RGM}		10	V
T_V T_{VJM} T_{stg}		-40...+125	°C
		125	
		-40...+125	
V_{ISOL}	50/60Hz, RMS $I_{ISOL} \leq 1mA$	$t = 1min$ 3000	V~
		$t = 1s$ 3600	
M_d	Mounting torque (M5) Terminal connection torque (M5)	2.5-4.0/22-35	Nm/lb.in.
		2.5-4.0/22-35	
Weight	Typical	78	g



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Thyristor-Diode Modules

Symbol	Test Conditions	Characteristic Values	Unit
I_{RRM}, I_{DRM}	$T_{VJ}=T_{VJM}; V_R=V_{RRM}; V_D=V_{DRM}$	5	mA
V_T, V_F	$I_T, I_F=320A; T_{VJ}=25^{\circ}C$	1.65	V
V_{TO}	For power-loss calculations only ($T_{VJ}=125^{\circ}C$)	0.85	V
r_T		3.2	$m\Omega$
V_{GT}	$V_D=6V;$ $T_{VJ}=25^{\circ}C$ $T_{VJ}=-40^{\circ}C$	1.5 1.6	V
I_{GT}	$V_D=6V;$ $T_{VJ}=25^{\circ}C$ $T_{VJ}=-40^{\circ}C$	100 200	mA
V_{GD}	$T_{VJ}=T_{VJM};$ $V_D=2/3V_{DRM}$	0.2	V
I_{GD}		10	mA
I_L	$T_{VJ}=25^{\circ}C; t_p=10\mu s; V_D=6V$ $I_G=0.45A; di_G/dt=0.45A/\mu s$	450	mA
I_H	$T_{VJ}=25^{\circ}C; V_D=6V; R_{GK}=\infty$	200	mA
t_{gd}	$T_{VJ}=25^{\circ}C; V_D=1/2V_{DRM}$ $I_G=0.45A; di_G/dt=0.45A/\mu s$	2	μs
t_q	$T_{VJ}=T_{VJM}; I_T=150A; t_p=200\mu s; -di/dt=10A/\mu s$ $V_R=100V; dv/dt=20V/\mu s; V_D=2/3V_{DRM}$	185	μs
Q_S	$T_{VJ}=T_{VJM}; I_T, I_F=50A; -di/dt=6A/\mu s$	170	μC
I_{RM}		45	A
R_{thJC}	per thyristor/diode; DC current per module	0.3 0.15	K/W
R_{thJK}	per thyristor/diode; DC current per module	0.5 0.25	K/W
d_s	Creeping distance on surface	12.7	mm
d_A	Strike distance through air	9.6	mm
a	Maximum allowable acceleration	50	m/s^2

FEATURES

- * International standard package
- * DCB base plate
- * Glass passivated chips
- * Isolation voltage 3600 V~
- * UL File NO.E310749
- * RoHS compliant

APPLICATIONS

- * DC motor control
- * Softstart AC motor controller
- * Light, heat and temperature control

ADVANTAGES

- * Space and weight savings
- * Simple mounting with two screws
- * Improved temperature and power cycling
- * Reduced protection circuits



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Thyristor-Diode Modules

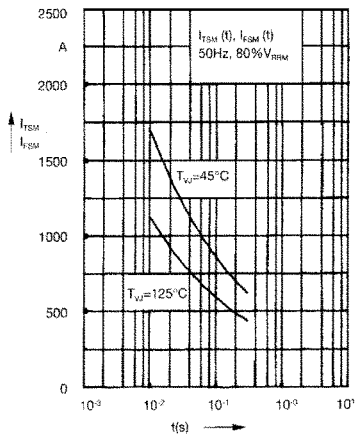


Fig. 1 Surge overload current
 I_{TSM}, I_{FSM} : Crest value, t : duration

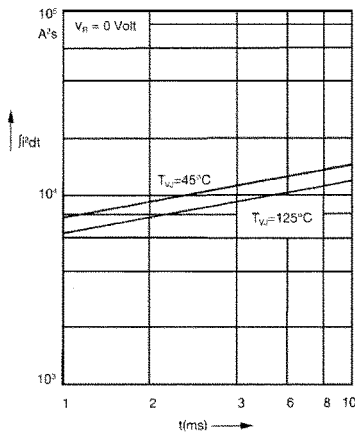


Fig. 2 $\int i^2 dt$ versus time (1-10 ms)

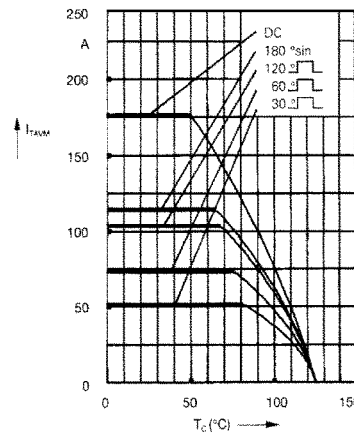


Fig. 2a Maximum forward current at case temperature

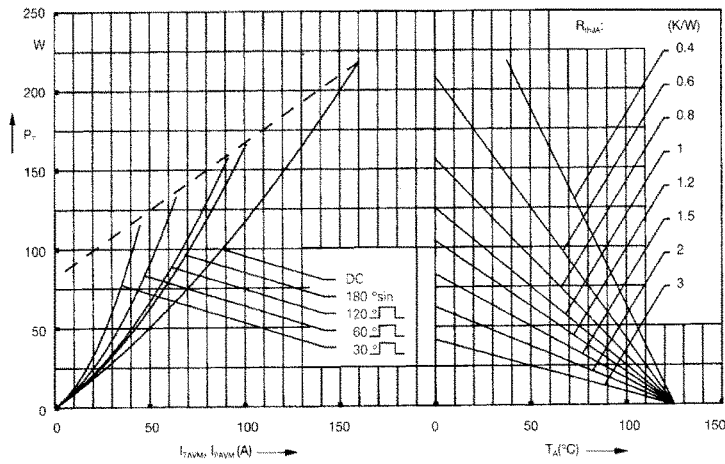


Fig. 3 Power dissipation versus on-state current and ambient temperature (per thyristor or diode)

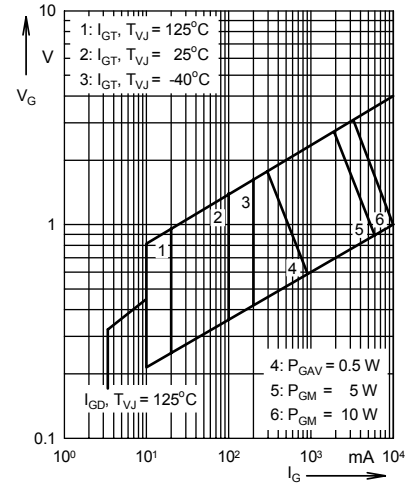


Fig. 4 Gate trigger characteristics

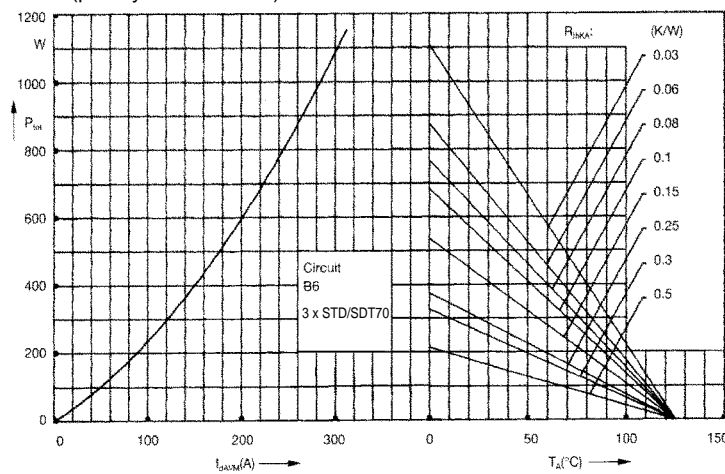


Fig. 5 Three phase rectifier bridge: Power dissipation versus direct output current and ambient temperature

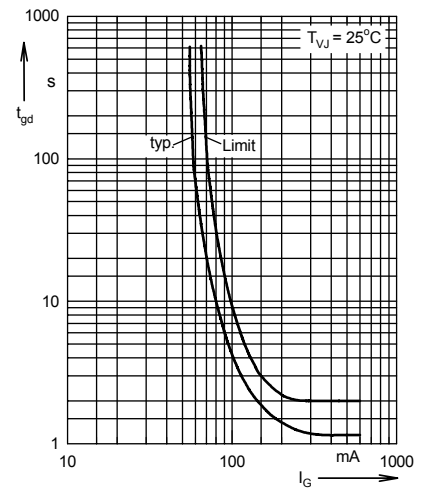


Fig. 6 Gate trigger delay time



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Thyristor-Diode Modules

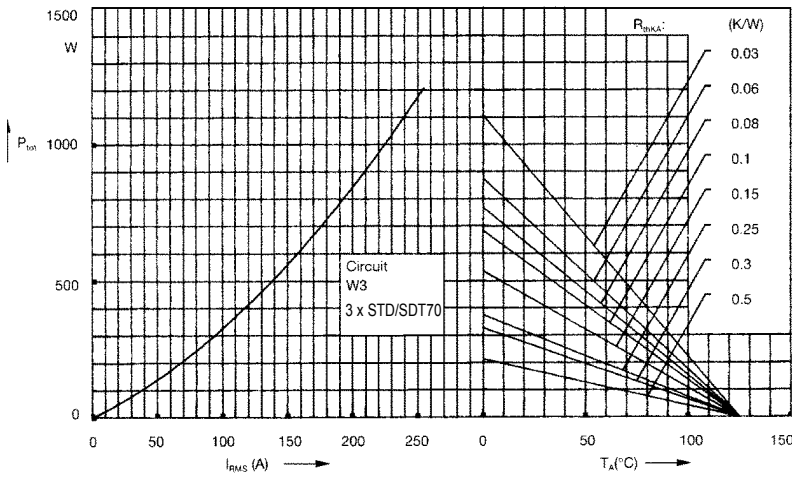


Fig. 7 Three phase AC-controller: Power dissipation versus RMS output current and ambient temperature

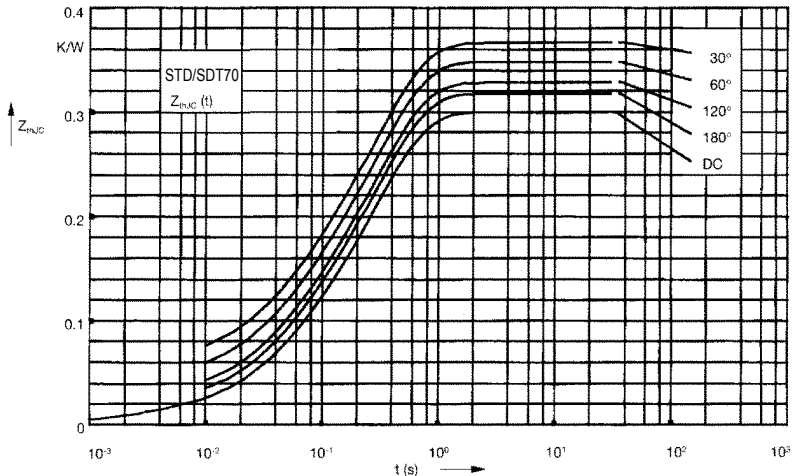


Fig. 8 Transient thermal impedance junction to case (per thyristor or diode)

R_{thJC} for various conduction angles d :

d	R_{thJC} (K/W)
DC	0.3
180°C	0.31
120°C	0.33
60°C	0.35
30°C	0.37

Constants for Z_{thJC} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.008	0.0019
2	0.054	0.047
3	0.238	0.3

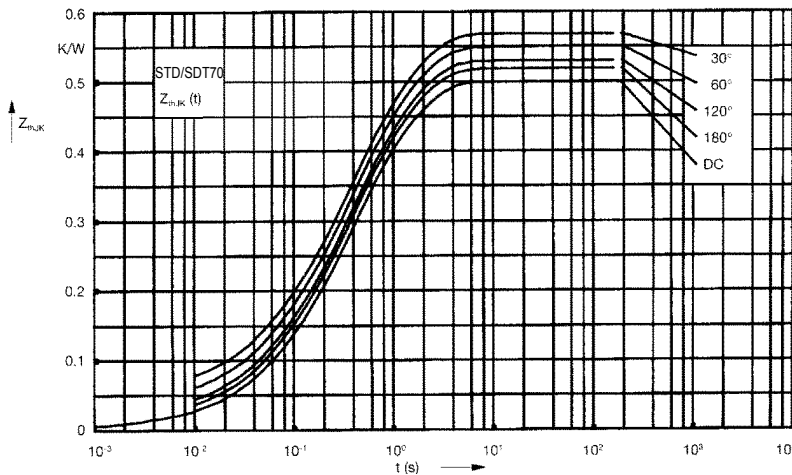


Fig. 9 Transient thermal impedance junction to heatsink (per thyristor or diode)

R_{thJK} for various conduction angles d :

d	R_{thJK} (K/W)
DC	0.5
180°C	0.51
120°C	0.53
60°C	0.55
30°C	0.57

Constants for Z_{thJK} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.008	0.0019
2	0.054	0.047
3	0.238	0.3
4	0.2	1.25

